

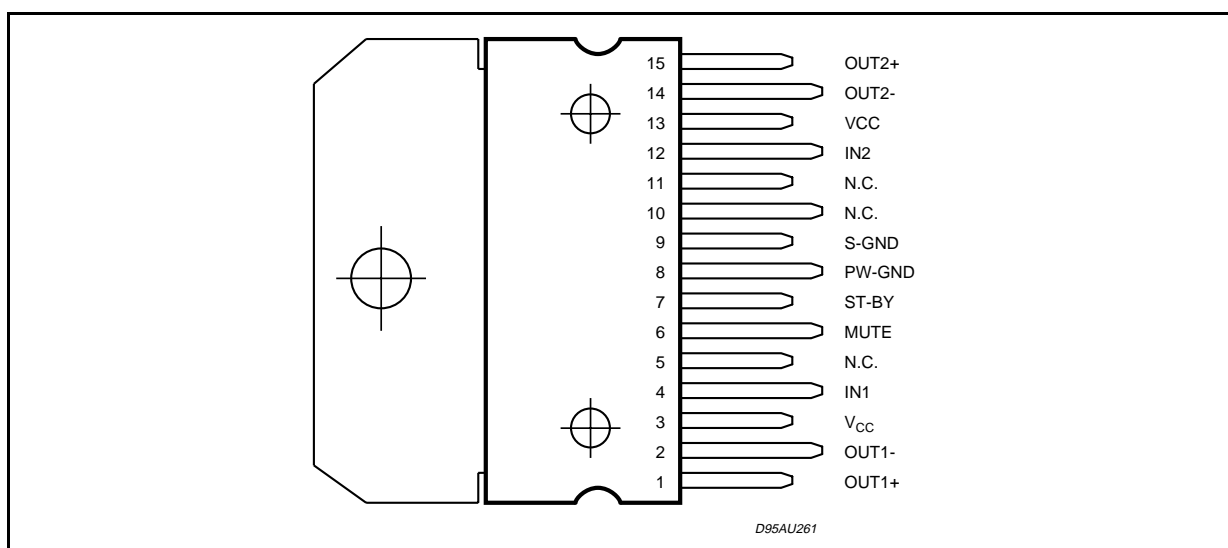
## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_S$	Supply Voltage	20	V
$I_O$	Output Peak Current (internally limited)	2	A
$P_{tot}$	Total Power Dissipation ( $T_{case} = 70^\circ\text{C}$ )	33	W
$T_{op}$	Operating Temperature	0 to 70	$^\circ\text{C}$
$T_{stg}, T_j$	Storage and Junction Temperature	-40 to +150	$^\circ\text{C}$

## THERMAL DATA

Symbol	Description	Value		Unit
$R_{th\ j-case}$	Thermal Resistance Junction to case	Typ. 1.4	Max. 2	$^\circ\text{C/W}$

## PIN CONNECTION (Top view)



**ELECTRICAL CHARACTERISTICS** ( $V_{CC} = 16.5\text{V}$ ,  $R_L = 8\Omega$ ,  $f = 1\text{kHz}$ ,  $T_{amb} = 25^\circ\text{C}$  unless otherwise specified.)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$V_{CC}$	Supply Range		6.5		18	V
$I_q$	Total Quiescent Current	$R_L = \infty$		50	65	mA
$V_{OS}$	Output Offset Voltage				120	mV
$P_O$	Output Power	THD = 10%	13	15		W
THD	Total Harmonic Distortion	$P_O = 1\text{W}$		0.1	0.3	%
		$P_O = 0.1\text{W to } 5\text{W}$ $f = 100\text{Hz to } 15\text{kHz}$			1	%
SVR	Supply Voltage Rejection	$f = 100\text{Hz } V_R = 0.5\text{V}$	40	56		dB
CT	Crosstalk		46	60		dB
$A_{MUTE}$	Mute Attenuation		60	80		dB
$T_W$	Thermal Threshold			150		$^\circ\text{C}$
$G_V$	Closed Loop Voltage Gain		31	32	33	dB
$\Delta G_V$	Voltage Gain Matching				0.5	dB
$R_i$	Input Resistance		25	30		$\text{K}\Omega$

## ELECTRICAL CHARACTERISTICS (Continued)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$V_{T\_MUTE}$	Mute Threshold	$V_O = -30\text{dB}$	2.3	2.9	4.1	V
$V_{T\_ST-BY}$	St-by Threshold		0.8	1.3	1.8	V
$I_{ST-BY}$	ST-BY current $V_6 = \text{GND}$				100	$\mu\text{A}$
$e_N$	Total Output Noise Voltage	A curve $f = 20\text{Hz to } 20\text{kHz}$		150 220	500	$\mu\text{V}$ $\mu\text{V}$

## APPLICATION SUGGESTION

## STAND-BY AND MUTE FUNCTIONS

## (A) Microprocessor Application

In order to avoid annoying "Pop-Noise" during Turn-On/Off transients, it is necessary to guarantee the right St-by and mute signals sequence. It is quite simple to obtain this function using a microprocessor (Fig. 1 and 2).

At first St-by signal (from  $\mu\text{P}$ ) goes high and the voltage across the St-by terminal (Pin 7) starts to increase exponentially. The external RC network is intended to turn-on slowly the biasing circuits of

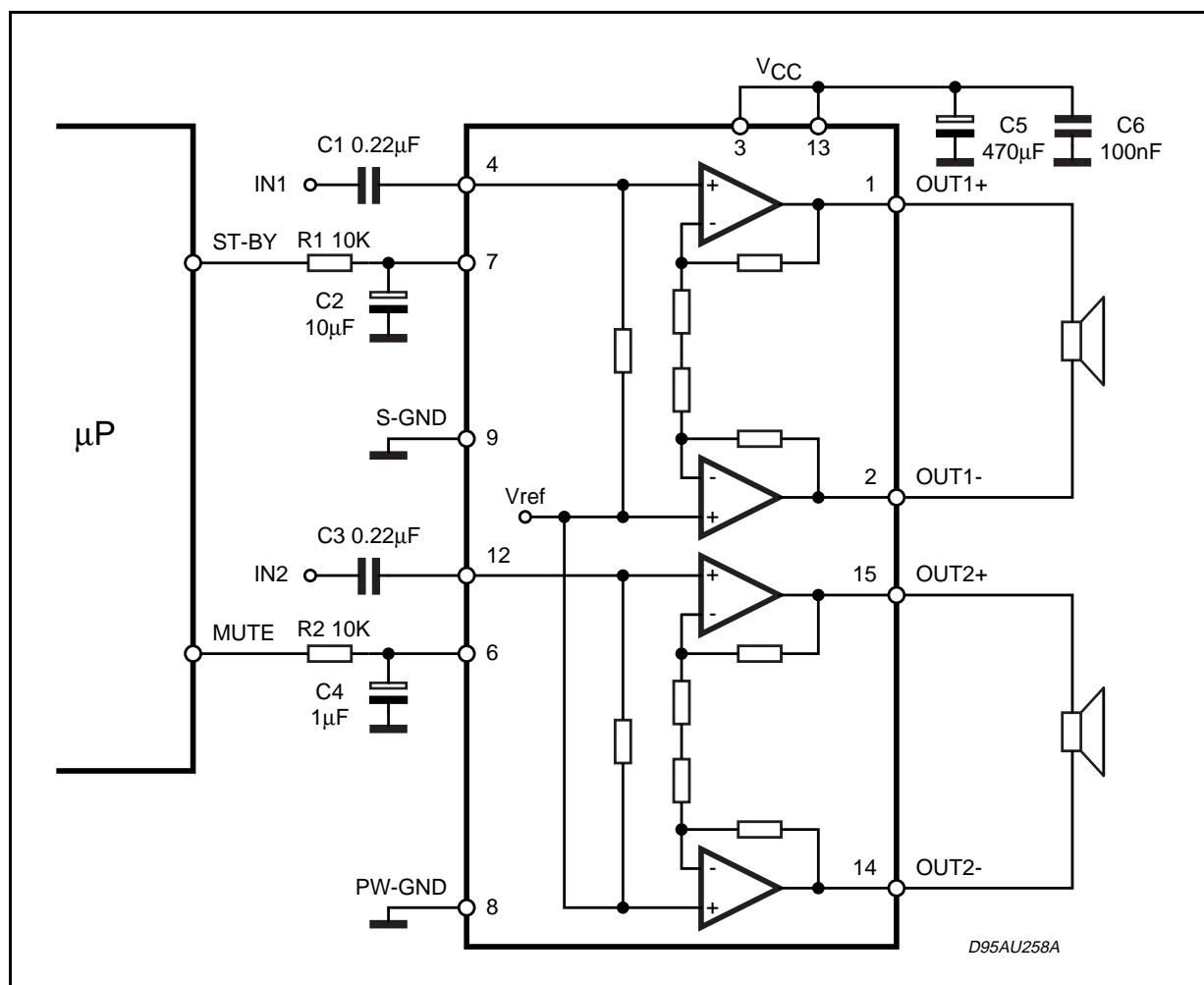
the amplifier, this to avoid "POP" and "CLICK" on the outputs.

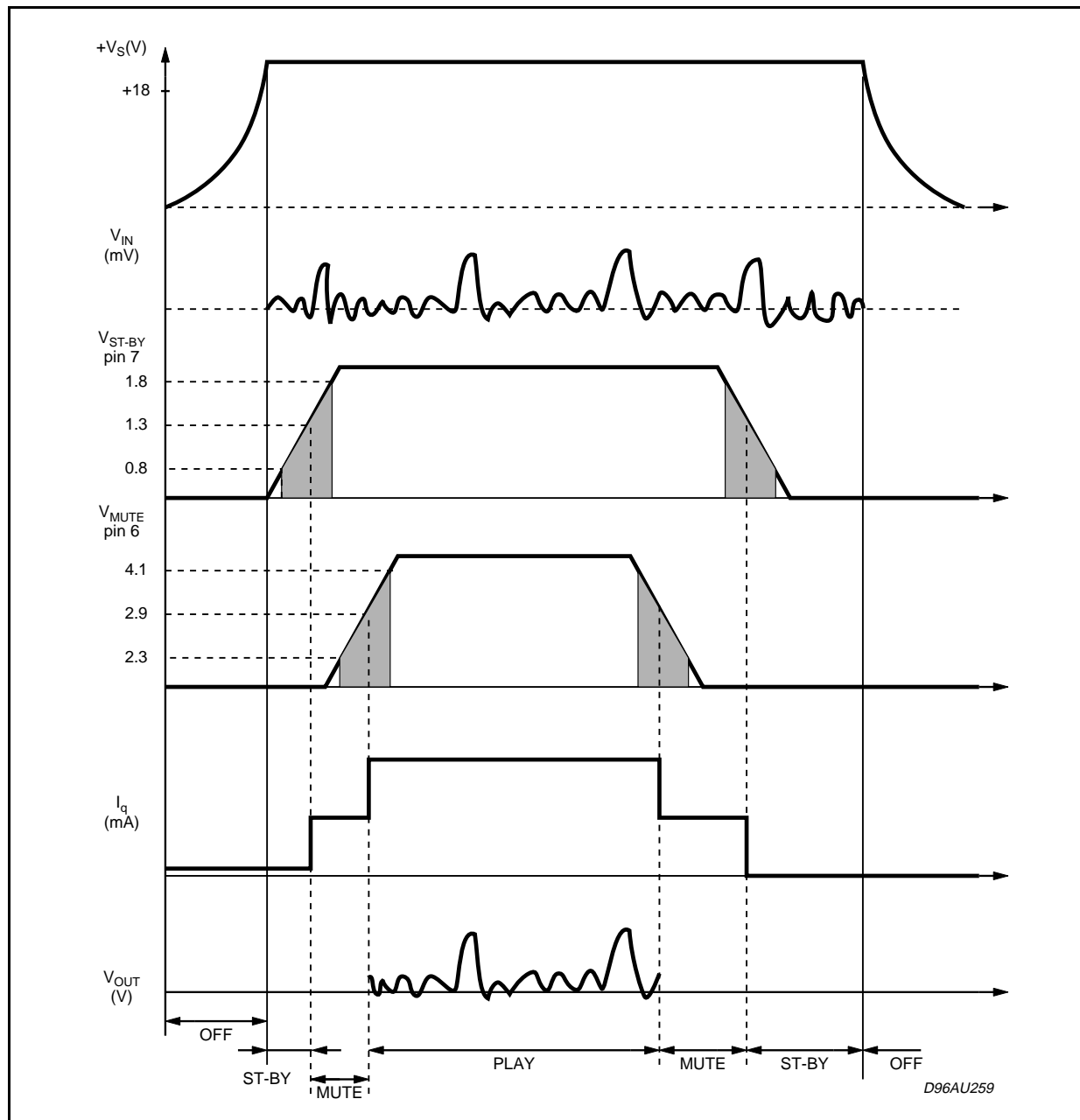
When this voltage reaches the St-by threshold level, the amplifier is switched-on and the external capacitors in series to the input terminals (C3, C5) start to charge.

It's necessary to maintain the mute signal low until the capacitors are fully charged, this to avoid that the device goes in play mode causing a loud "Pop Noise" on the speakers.

A delay of 100-200ms between St-by and mute signals is suitable for a proper operation.

Figure 1: Microprocessor Application



**Figure 2:** Microprocessor Driving Signals.**(B) Low Cost Application**

In low cost applications where the mP is not present, the suggested circuit is shown in fig.3.

The St-by and mute terminals are tied together and they are connected to the supply line via an

external voltage divider.

The device is switched-on/off from the supply line and the external capacitor C4 is intended to delay the St-by and mute threshold exceeding, avoiding "Popping" problems.

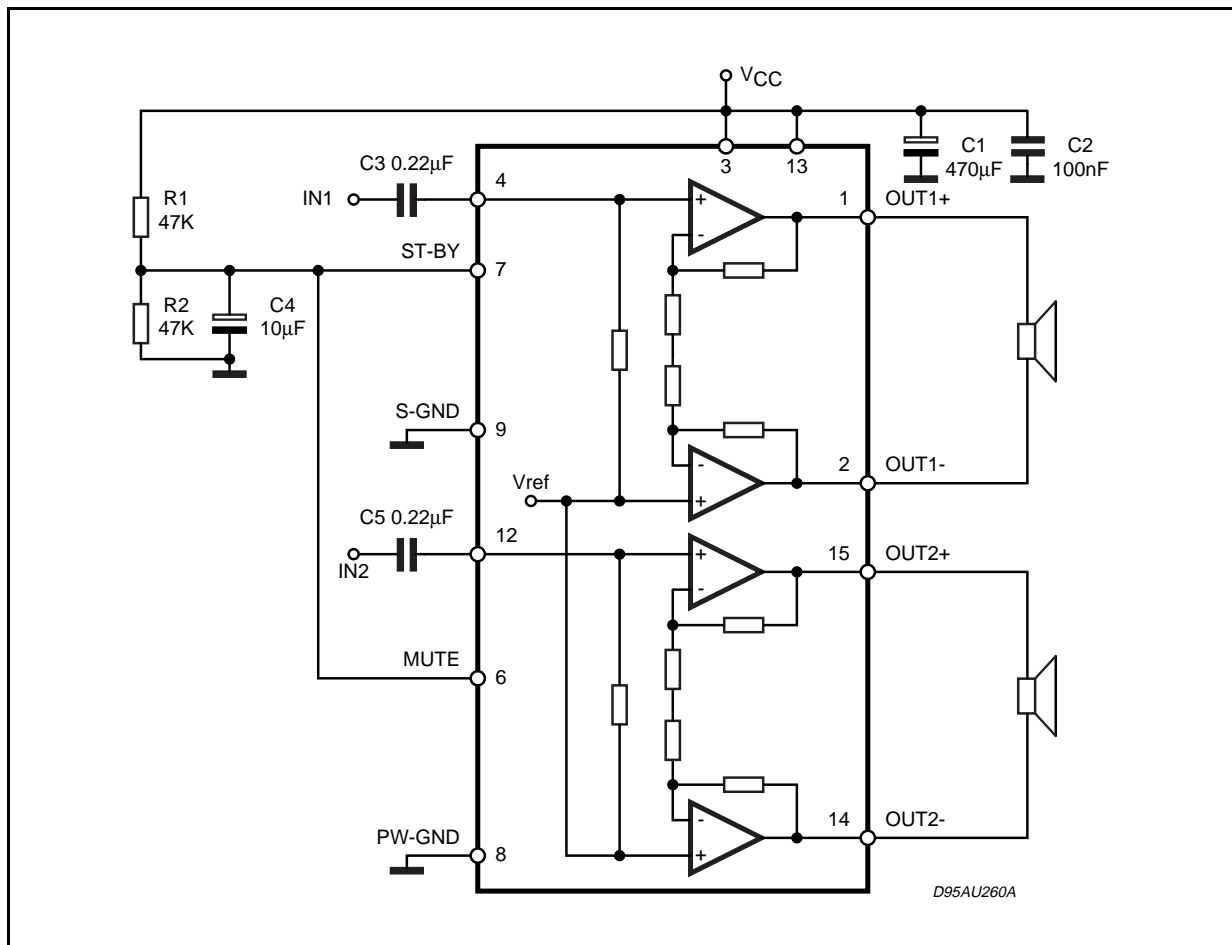
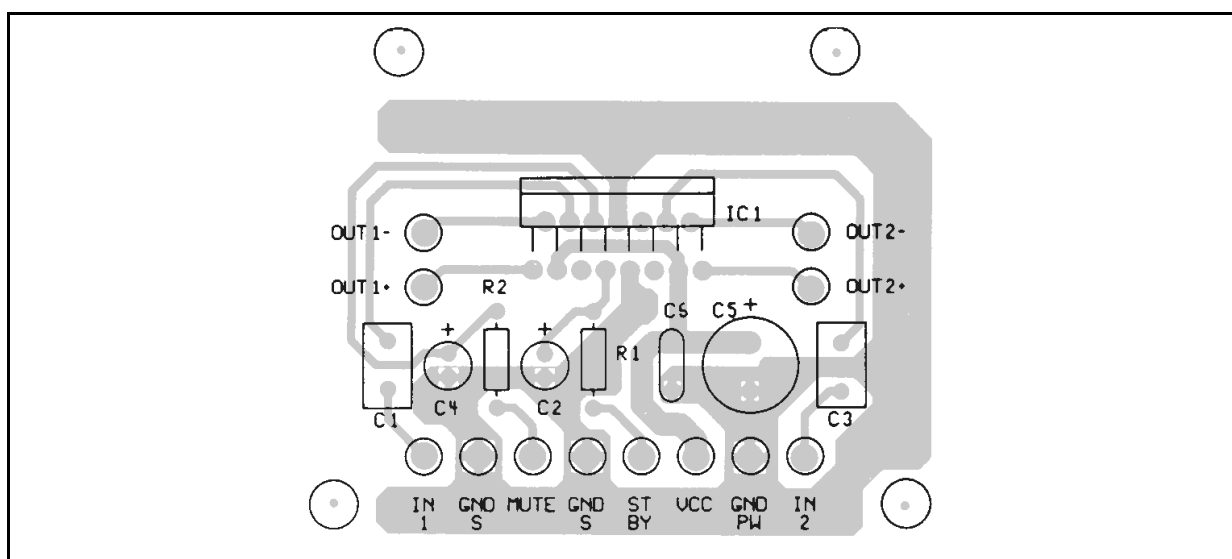
**Figure 3:** Stand-alone Low-cost Application.**Figure 3b:** PCB and Component Layout of the Application Circuit (Fig. 1).

Figure 4: Distortion vs Output Power

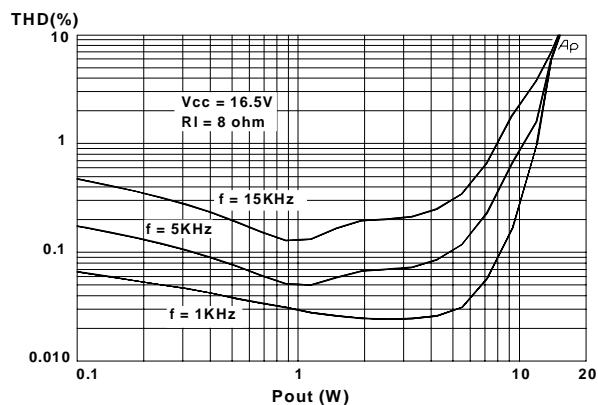


Figure 5: Distortion vs Output Power

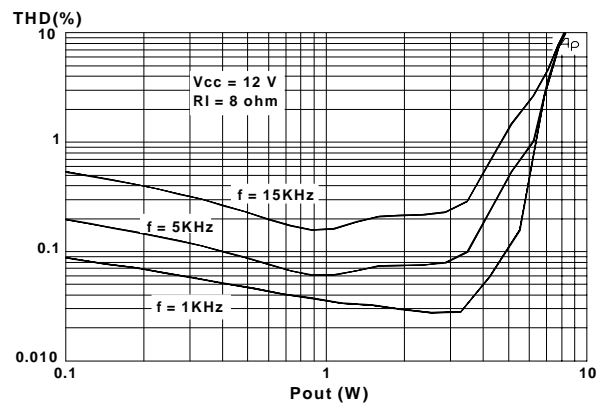


Figure 6: Distortion vs Frequency

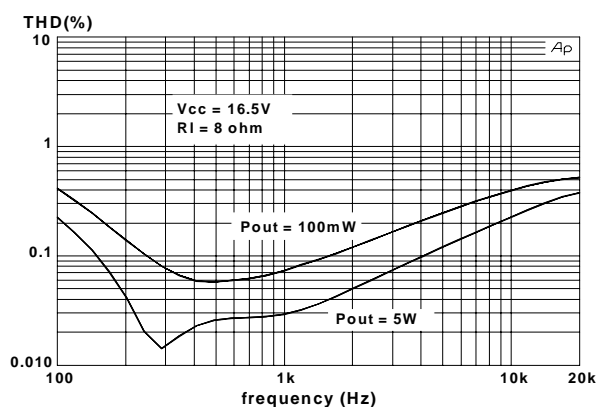


Figure 7: Frequency Response

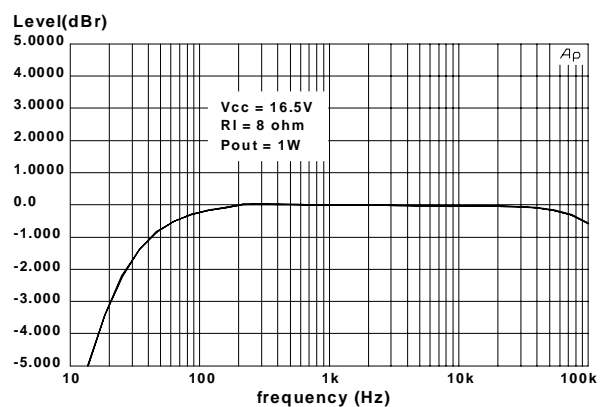


Figure 8: Output Power vs Supply Voltage

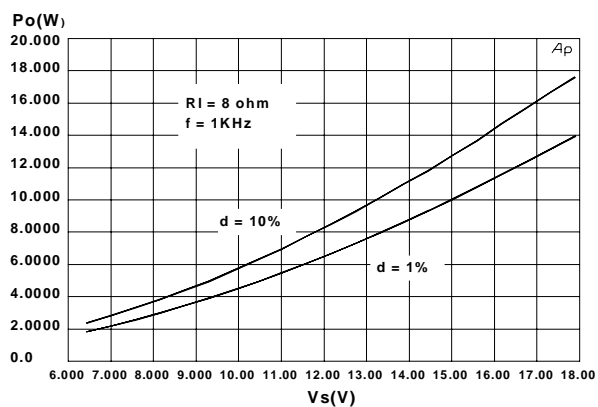


Figure 9: Total Power Dissipation &amp; Efficiency vs Output Power

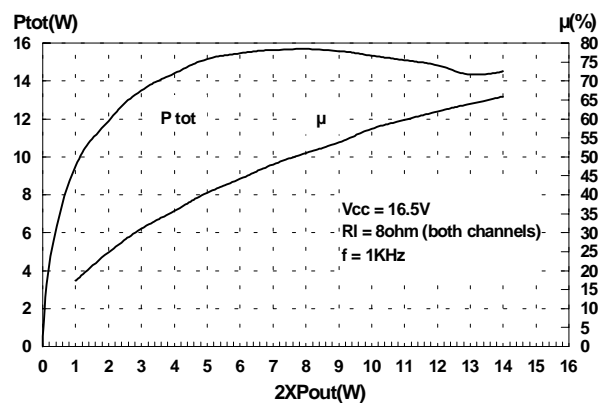


Figure 10: Mute Attenuation vs. V pin.6

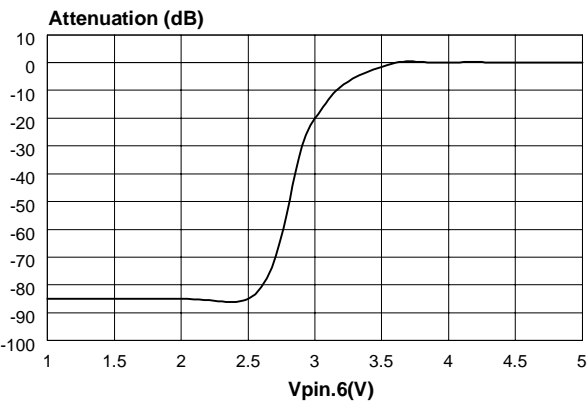


Figure 11: Stand-By Attenuation vs Vpin.7

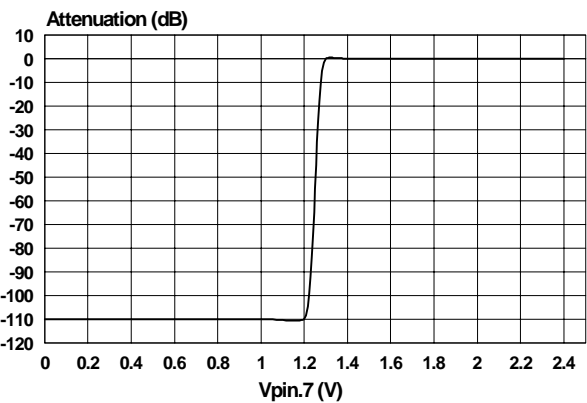
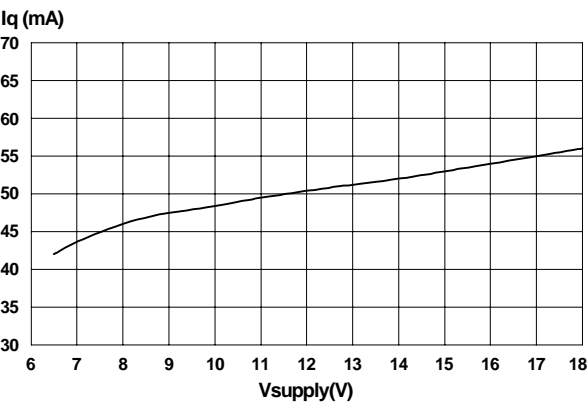


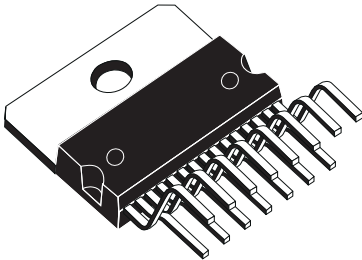
Figure 12: Quiscent Current vs. Supply Voltage



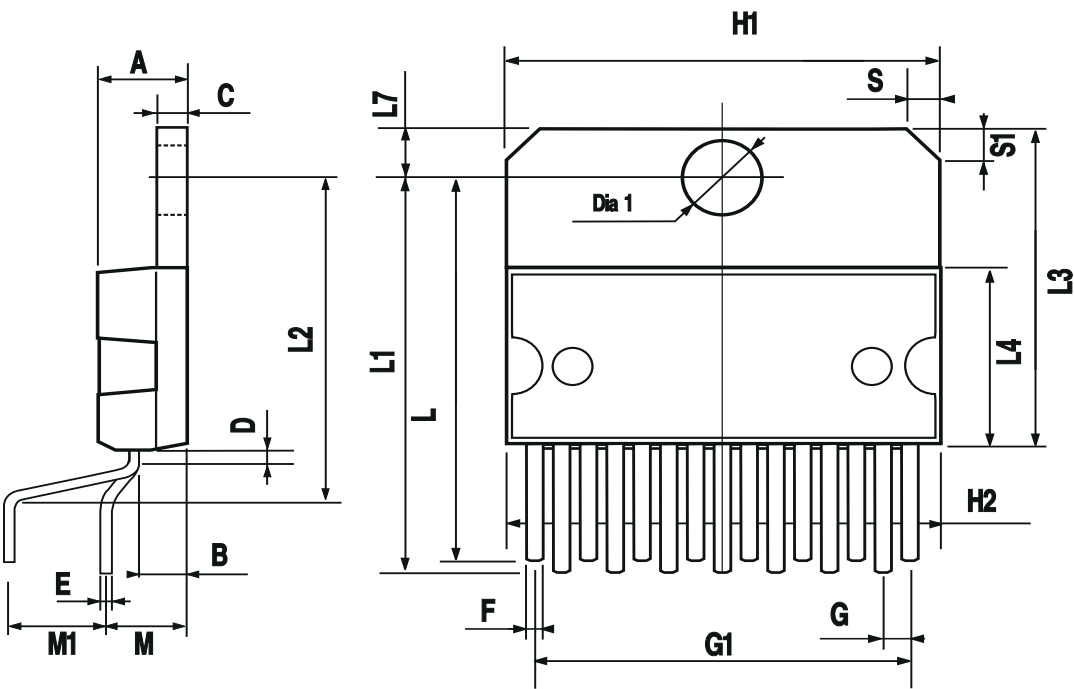
**TDA7297**

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			5			0.197
B			2.65			0.104
C			1.6			0.063
D		1			0.039	
E	0.49		0.55	0.019		0.022
F	0.66		0.75	0.026		0.030
G	1.02	1.27	1.52	0.040	0.050	0.060
G1	17.53	17.78	18.03	0.690	0.700	0.710
H1	19.6			0.772		
H2			20.2			0.795
L	21.9	22.2	22.5	0.862	0.874	0.886
L1	21.7	22.1	22.5	0.854	0.870	0.886
L2	17.65		18.1	0.695		0.713
L3	17.25	17.5	17.75	0.679	0.689	0.699
L4	10.3	10.7	10.9	0.406	0.421	0.429
L7	2.65		2.9	0.104		0.114
M	4.25	4.55	4.85	0.167	0.179	0.191
M1	4.63	5.08	5.53	0.182	0.200	0.218
S	1.9		2.6	0.075		0.102
S1	1.9		2.6	0.075		0.102
Dia1	3.65		3.85	0.144		0.152

**OUTLINE AND  
MECHANICAL DATA**



**Multiwatt15 V**



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